CLAIMS

1. A method of manufacturing a group III-V crystal, characterized in comprising: a step of depositing a metal film on a substrate; a step of heat-treating the metal film under an atmosphere in which a patterning compound is present; and a step of growing a group III-V crystal on the post-heat-treated metal film.

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- 2. A method of manufacturing a group III-V crystal, characterized in comprising: a step of depositing a metal film on a substrate; a step of heat-treating the metal film under an atmosphere in which a patterning compound is present; a step of growing a group III-V compound buffer film on the post-heat-treated metal film; and a step of growing a group III-V crystal on the group III-V compound buffer film.
- 3. A group III-V crystal manufacturing method as set forth in either claim 1 or 2, characterized in that holes or grooves formed in the metal film by the heat-treating of the metal film under an atmosphere in which a patterning compound is present have an average width of 2 nm to 5000 nm, and the aperture fraction, being the percentage of the surface area that the holes or grooves occupy with respect to the substrate total surface area, is 5% to 80%.
- 4. A group III-V crystal manufacturing method as set forth in any of claims 1 to 3, characterized in that the substrate is silicon, sapphire, SiC, ZrB₂, or a group III-V compound.
 - 5. A group III-V crystal manufacturing method as set forth in any of

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claims 1 to 4, characterized in that the metal film contains titanium or vanadium.

- 6. A group III-V crystal manufacturing method as set forth in any of claims 1 to 5, rendering the thickness of the metal film 10 nm to 1000 nm.
- 7. A group III-V crystal manufacturing method as set forth in any of claims 1 to 6, characterized in that the heat treatment is carried out at 800°C to 1200°C for 0.5 minutes to 20 minutes.
 - 8. A group III-V compound crystal manufactured by a group III-V crystal manufacturing method as set forth in any of claims 1 to 7.
- 9. A group III-V compound crystal as set forth in claim 8, the III-V crystal being $Ga_xAl_yIn_{1-x-y}$ ($0 \le x \le 1$ and $0 \le y \le 1$).